

# Modeling CMOS Non-Quasi-Static Effects in a Quasi-Static Simulation Engine

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## Outline

- What is the NQS problem?
- Formulation of NQS simulation
- Approximate solution for fast transient
- Frequency domain solution
- Summary



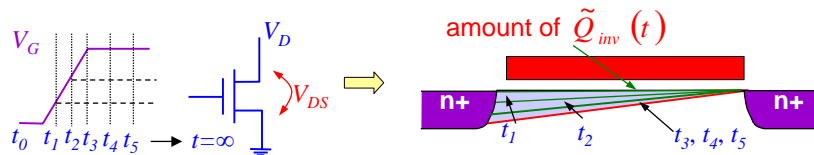
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## The Non-Quasi-Static Problem [1]

### ■ what happens at fast transient?

- at slow switching



- charge at given time is known once apply voltages are given

$$\tilde{Q}(t) \approx f(V_D(t), V_S(t), V_G(t), V_B(t), t = \infty) = \tilde{Q}(\tilde{V}(t), t = \infty)$$

- quasi-static assumption is valid

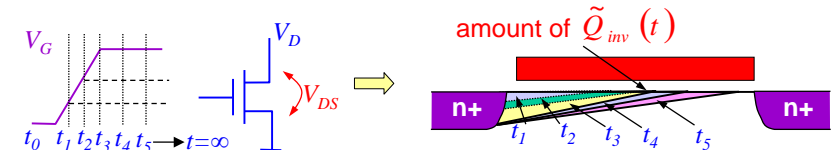


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## The Non-Quasi-Static Problem [2]

- at fast switching



- charge at given time is unknown with given apply voltages

$$\tilde{Q}(t) = f(V_D(t), V_S(t), V_G(t), V_B(t), t) \neq \tilde{Q}(\tilde{V}(t), t = \infty)$$

- quasi-static assumption is invalid



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# The Non-Quasi-Static Problem [3]

## what is quasi-static assumption?

- most precisely defined by Yannis Tsividis
  - let  $V_D(t), V_S(t), V_G(t), V_B(t)$  be the varying terminal voltages; then at any position, the charges per unit area at any time  $t$  are assumed identical to those that would be found if DC voltages  $V_D=V_D(t), V_S=V_S(t), V_G=V_G(t), V_B=V_B(t)$  were used instead
  - that is: we assume charge is a memoryless state variable

## why quasi-static assumption?

- SPICE does not keep track of the time, and only guesses of voltages are provided to solve the linear iterative equation

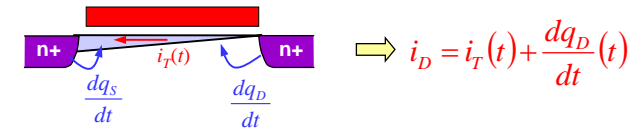
$$\tilde{g}^m \tilde{V}^{(m+1)} = -\tilde{I}^m + \tilde{g}^m \tilde{V}^m$$



# Approach of QS Approximation

## calculation of drain current

- compose of a transport current plus a charging current



## 2 problems:

- how to calculate the transport current?
- we know how to calculate the channel charge (to some degree), but don't know how to partition the channel charge to the source and drain



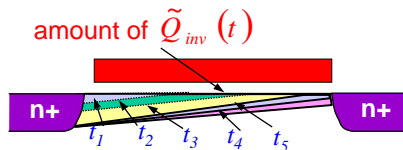
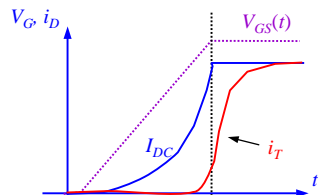
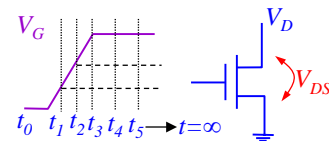
# Approximating Transport Current

- assume the transport current is the same as the DC current at the given voltage (QS approximation)

$$i_T(t) \approx I(\tilde{V}(t), t = \infty) = I_{DC}(\tilde{V}(t))$$

## problem:

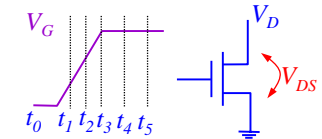
- check current at different time



# Another Attempt of Approximation

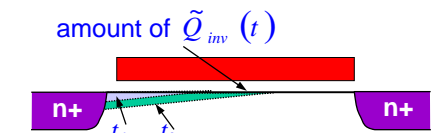
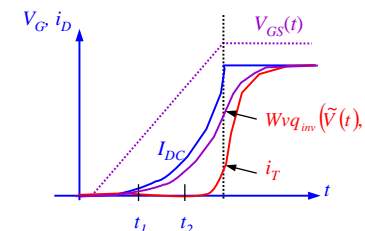
- use transient charge to calculate the transport current

$$i_T(t) \approx Wvq_{inv}(\tilde{V}(t), t)_{\text{some location } y}$$



## problem:

- knowing the amount of charge alone is insufficient, and the spatial distribution is also required



- location information also not available in SPICE

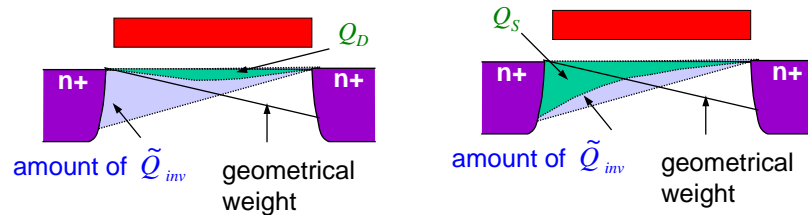


# Charge Partition Scheme [1]

## Charging current: Fixed charge partition

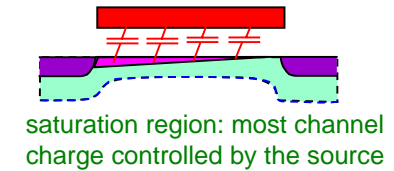
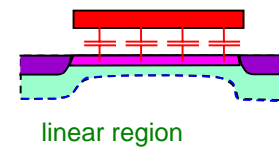
- 40/60 charge partition
  - based on geometrical weighted integral

$$Q_D = \int_0^L \frac{y}{L} q_i(y) dy \quad \text{and} \quad Q_S = \int_0^L \left(1 - \frac{y}{L}\right) q_i(y) dy$$



# Charge Partition Scheme [2]

- 0/100 charge partition
  - missing part of 40/60 charge partition
  - based on pinch-off approximation

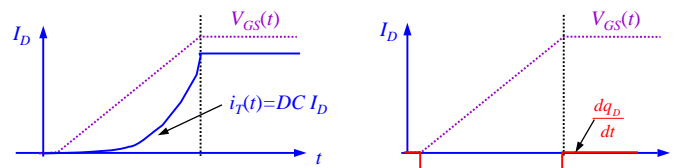


- 50/50 charge partition
  - sort of arbitrary and seldom used these days

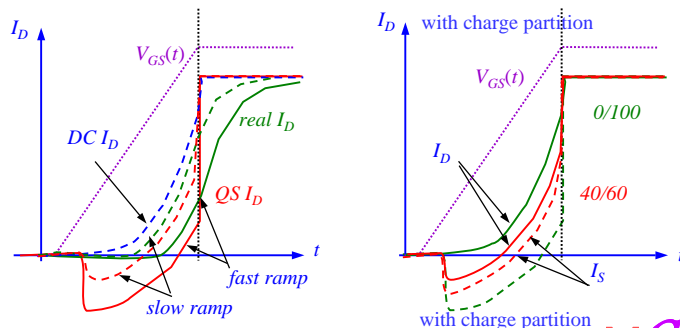
# Simulation result with Charge Partition

## Results of QS approximations

- individual component



- final output



# Measuring the Charge Partition [1]

## How to measure the NQS charge partition

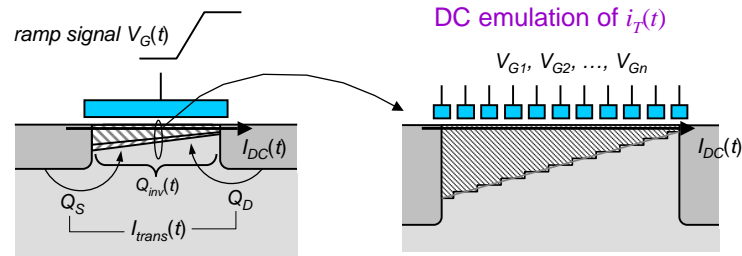
- can be measured by the drain and source current

$$\begin{cases} i_D = i_T(t) + \frac{dq_D}{dt}(t) = i_T(t) + x \frac{dq_{inv}}{dt}(t) \\ i_S = -i_T(t) + \frac{dq_S}{dt}(t) = -i_T(t) + (1-x) \frac{dq_{inv}}{dt}(t) \end{cases}$$

- the 2 equations are linearly dependent
- need to find  $-i_T(t)$  in order to find the value of  $x$

# Measuring the Charge Partition [2]

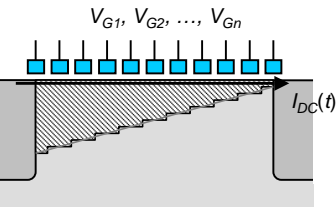
## By using 2-D simulator



$$i_D = i_T(t_p) + x \frac{dq_D}{dt}(t_p)$$

$$i_S = -i_T(t_p) + (1-x) \frac{dq_S}{dt}(t_p)$$

DC emulation of  $i_T(t)$



$$i_D = i_T(t_p) = I_{DC}$$

$$i_S = i_T(t)$$

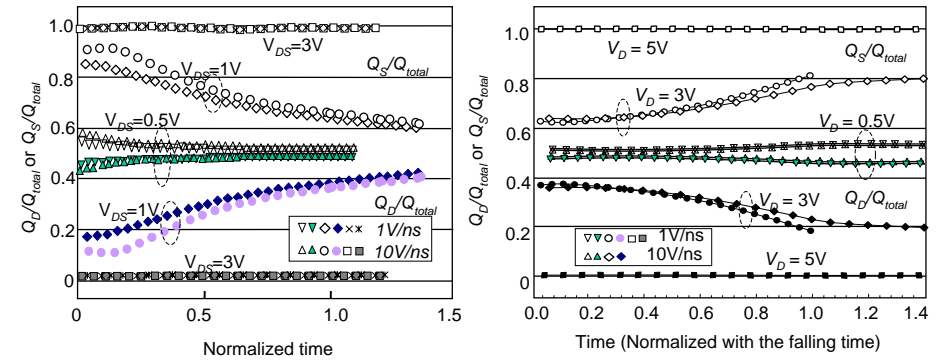
- drain/source current ratio can be found by subtracting current in the left figure by current in the right figure



# Actual Channel Charge Partition

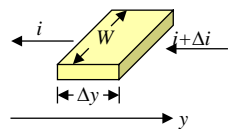
## Turn-on and Turn-off charge partition ratio

- Charge partition is dynamic dependent on ramp rate



# Exact Solution of MOSFET

## Consider strong inversion only



• continuity equation  $\frac{\partial i(y,t)}{\partial y} = W \frac{\partial q_i(y,t)}{\partial t}$

• drift diffusion  $i(y,t) = \mu W q_i(y,t) \frac{\partial v_{CB}(y,t)}{\partial t}$

- charge control equation

$$q_i(y,t) = C_{ox} (v_{GB}(t) - V_{FB} - \phi_0 - v_{CB}(y,t) - \gamma \sqrt{\phi_0 + v_{CB}(y,t)})$$

- terminal currents are given by  $i_D(t) = i(L,t)$  and  $i_S(t) = i(0,t)$

- total inversion charge is given by  $Q_{inv} = \int_0^L q_i(y,t) dy$

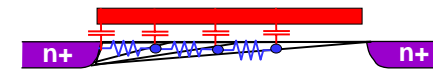
- question: how to incorporate this into a compact model?



# Approximate Compact Model [1]

## By using distributed network

- using more internal nodes to keep track of the timing



- need charge and I-V expression at each internal node

## Common implementation

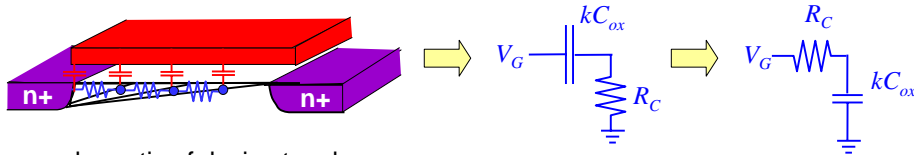


- transport current remain Quasi-static
- need a correct charge partition model

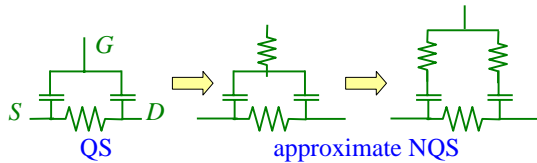


# Approximate Compact Model [2]

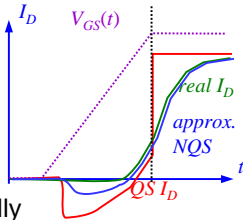
## Further simplification



- schematic of device topology

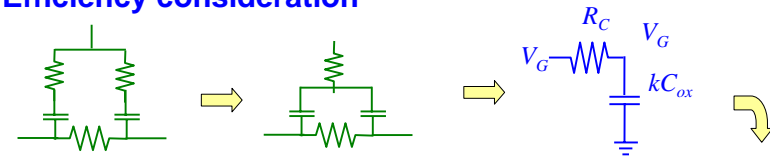


- successfully includes the delay, but remains physically incorrect QS transport current and charge partition scheme



# Implementation of NQS Model in BSIM

## Efficiency consideration



requires 2 additional nodes

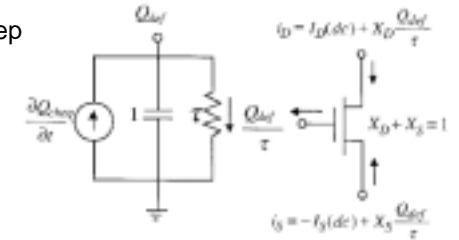
inflexible to include charge partition

Using external circuit

- A state variable  $Q_{def}$  is created to keep track of the deficit charge and the charging current is calculated by

$$\frac{dQ_{def}(t)}{dt} = \frac{dQ_{cheq}(t)}{dt} - \frac{dQ_{ch}(t)}{dt}$$

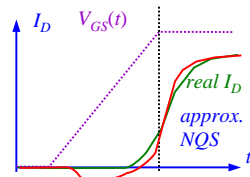
and  $\frac{dQ_{ch}(t)}{dt} \approx \frac{Q_{def}(t)}{\tau}$



# Limitation in BSIM's NQS Approach

## What can be achieved using the BSIM NQS model?

- Correct delay in digital switching can be predicted



## Limitation of the BSIM NQS approach

- The use of  $I_D(dc)$  is physically incorrect
- Charge partition should be dependent on the drain voltage (linear region is 50/50), but initial implementation in BSIM does not allow it
- Need to partition the deficit charge to the gate and substrate, which is not done in BSIM
- Can predict the delay in digital switching (for speed estimation) but no guarantee the waveform is correct



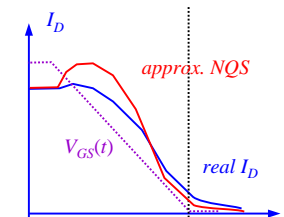
# Effect of Velocity Saturation

## Limitation of the gradual channel approximation

- The gradual channel approximation assume the channel is in-contact with the drain terminal at "pinch-off"
- Velocity saturation introduce extract resistance at the drain, as current cannot travel faster than  $v_{sat}$  to the drain



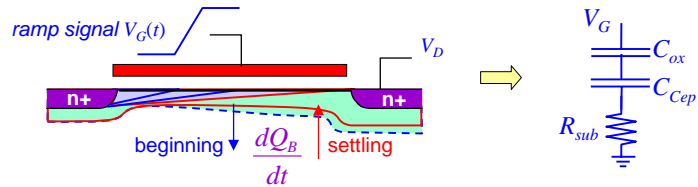
- Observation during turn-off, an overly large drain current overshoot is observed in the approximate model



# Action of Depletion Charge

## At the drain region during turn-on

- The drain region at high drain voltage can enter deep-depletion before the charge from the source arrived

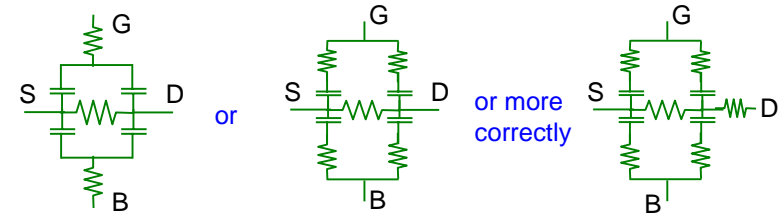


- Initially, depletion charge extended beyond the equilibrium through a current path controlled by the substrate resistance
- Once the carriers from the source reached the drain, the depletion is converted back to the inversion charge
- Not only affecting  $I_{sub}$ , but also create a dynamic effect in the threshold voltage or surface potential

# Modification of Approximate NQS Model

## Required enhancement in approximate model

- need one more node to include the action of substrate charge



- Actual implementation is more complicated than the above circuit as the distributed resistance from the drain to the channel is required to allow the coupling between the gate and substrate

# Unpublished BSIM Enhancement

- A new variable  $Q_{exc}$  has been defined to keep track of the excess substrate charge from equilibrium

$$\frac{dQ_{exc}}{dt} = \frac{dQ_B}{dt} - \frac{dQ_{Beq}}{dt}$$

where  $\frac{dQ_B}{dt} = \frac{dQ_B}{dt} \Big|_{in} + \frac{dQ_B}{dt} \Big|_{out} \approx \frac{Q_{def} - Q_{exc}}{n_B \tau_B}$

therefore  $\frac{dQ_{exc}}{dt} \approx \frac{Q_{def} - Q_{exc}}{n_B \tau_B} - \frac{dQ_{Beq}}{dt}$

The substrate current can be calculated by the another sub-circuit as shown

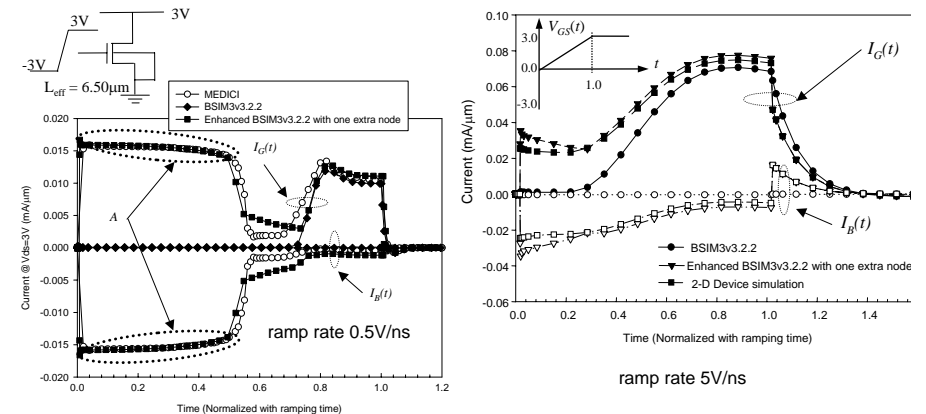
$$i_D = I_{DC} + \frac{Q_D}{Q_{cheq}} \times \frac{Q_{def}}{\tau}$$

$$i_s = -I_{DC} + \frac{Q_S}{Q_{cheq}} \times \frac{Q_{def}}{\tau}$$

# Gate and Substrate Currents

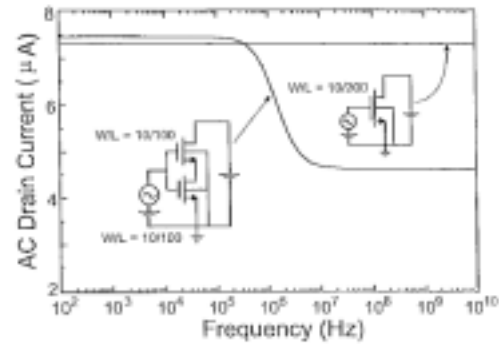
## Result of the BSIM enhancement

- Turn-on of a 6.50μm NMOS transistor with input ramp rate 0.5V/ns



## What About Small Signal AC Simulation?

### Pointed out by Tsividis



- This is a mis-conception of NQS effect and this behavior can be modeled well by adding a pole by the inclusion of gate resistance as in the BSIM model

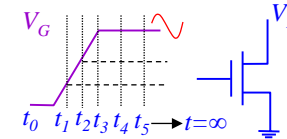


## NQS Effect in AC Simulation?

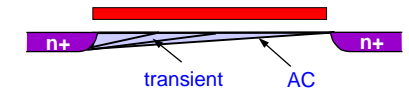
### Recall definition of QS assumption

$$\tilde{Q}(t) = f(\tilde{V}(t), t) \approx f(\tilde{V}(t), t = \infty)$$

- in AC, all node voltages are equal to the voltages at  $t = \infty$ , thus the above equation becomes an equality



$$\tilde{Q}(t = \infty) = f(\tilde{V}(t = \infty), t = \infty)$$



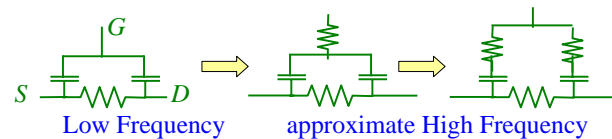
- Strictly speaking, NQS refers to Large Signal non-equilibrium
- AC small signal simulation is always static
- NQS effects may become important when large signal simulation is used to general high frequency response by using Fourier Transforms



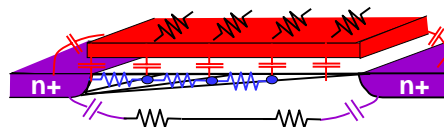
## Modeling MOSFET for HF AC Simulation

### Real problem:

- How to model the distributed RLC network after reaching equilibrium!!
- It is really quasi-static
- The distributed RC approach works pretty well



- More internal nodes will help



- Question: Can we have a separate large signal and small signal model with different number of nodes?



## Result of Distributed RC Network Model



## How Serious is the NQS Problem?

### For Digital Circuits

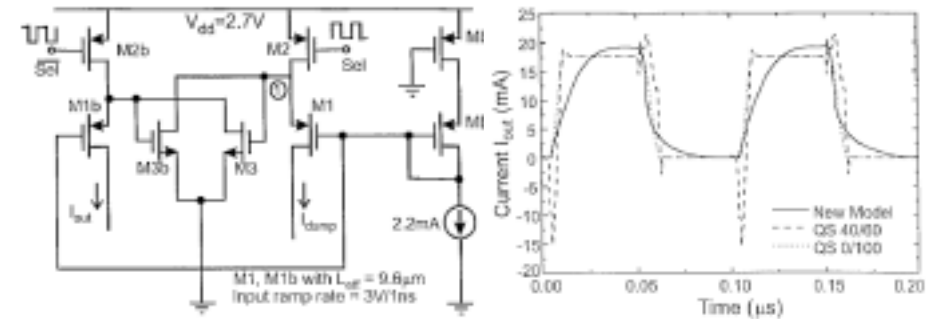
- never happens in self driven switching circuits (most circuits)
- only happens when a small (fast) device is driving a large (slow) device
- conclusion: can be ignored in most digital circuits

### For High Frequency Circuits

- Only in large signal switching circuits (like oscillator) that use Fourier Transform to obtain the frequency response
- QS approximation works pretty well up to about  $0.05f_T$
- with increasing  $f_T$  in nano-CMOS, NQS problem maybe over worried



## Example Circuit that Require NQS Model



- An A/D current source with  $0.6\mu\text{m}$  technology
- The delay is correctly predicted, but no guarantee on waveform



## Summary

- The current compact modeling approach are inherently Quasi-Static
- NQS effects is a result of large signal non-equilibrium situation during switching
- Most Compact NQS model uses the distribute RC network to emulate the NQS switching, which provide some degree of similarity despite incorrect RC elements used
- Frequency domain simulation is always Static, and no NQS event in a strict sense
- The NQS problem is somehow over exaggerated

